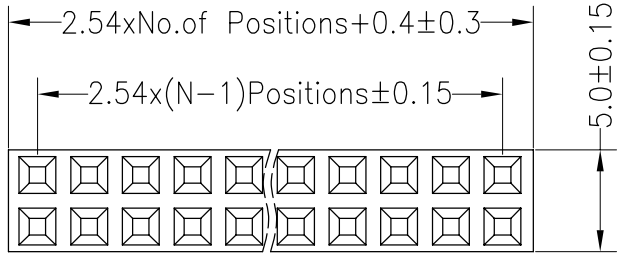
HSF RoHS

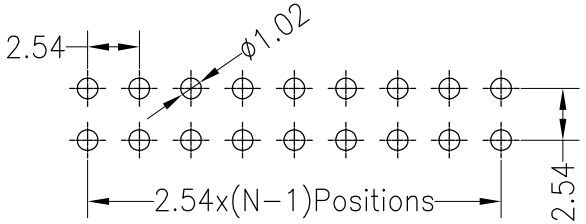
FILE NO :E362810

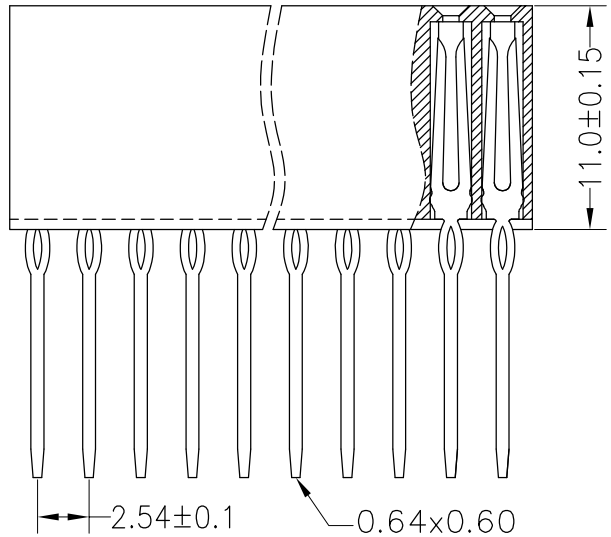
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

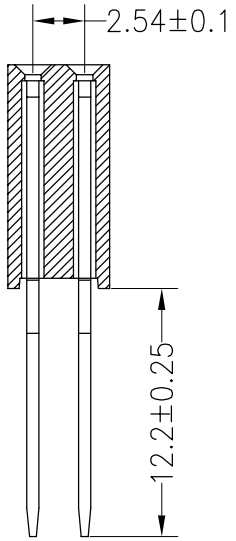
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PBT
Max.Processing Temp: 180°C for 30−60 seconds
(200°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

2211P-02 XX X N XX SYX 01

- No.of Pins: 2*2~2*40
- Insulator Material Option: A=BK−PBT; B=BK−PA66; C=BK−PA6T; D=BK−PA46; E=BK−PA9T; F=BK−LCP
- Contact Plating: G0:Gold Flash; G1:3U" Gold; G2:5U" Gold; G3:10U" Gold; G4:15U" Gold; G5:30U" Gold; S0:Gold Flash/Tin; SN:Tin
- Packing: 0=PE Bag; A=Tray; T=Tube

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.03.28	NEW DRAWING	

OPERATION	
X.X	±0.30
X.XX	±0.20
X.XXX	±0.10
Angle	±3°
DIM	TOL

DRAW	Liu Miao	12.03.28
CHECK		
APPROVE		

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	2211P02XXXNXXSYX01
TITLE:	2.54PF H11.0mm 2xNpin 180° W5.0mm